

REMARKS

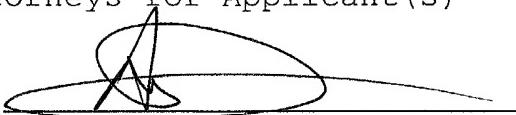
The specification is being amended to update the Cross-Reference to Related Applications section and to provide consistency with the formal drawings submitted.

Favorable consideration is respectfully solicited.

Respectfully submitted,

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VERSION WITH MARKINGS TO SHOW CHANGES MADE

IN THE SPECIFICATION

The paragraph beginning at page 1, line 4, has been replaced with the following rewritten paragraph:

~~The present application claims priority from U.S. provisional applications serial no. 60/050,274, filed June 20, 1997, and serial no. 60/055,287, filed August 13, 1997, the entire contents of which are hereby incorporated by reference.~~

This is a divisional of application no. 09/446,188, filed May 8, 2000, which is a 371 national stage application PCT/US98/12768, filed June 19, 1998, which claims the benefit of priority from U.S. provisional application nos. 60/050,274, filed June 20, 1997, and 60/055,287, filed August 13, 1997, the entire contents of application nos. 09/446,188, PCT/US98/12768, 60/050,274, and 60/055,287 are hereby incorporated by reference.

The paragraph beginning at page 7, line 11, has been replaced with the following rewritten paragraph:

Figure 1A is a schematic of an electrospray process illustrating the different state of the sprayed substance at different distances from the electrospray capillary tip.

Figure 1B is an enlarged partial view of Fig. 1A showing that

Microdroplets of solution predominate in the wet zone, and dry clusters and ions predominate in the dry zone.

The paragraph beginning at page 8, line 9, has been replaced with the following rewritten paragraph:

Figure 9A schematically shows the mass fabrication of multicomponent matrices by using a means for shifting the position of the mask relative to the substrate after each of a series of substances are electrodeposited onto a substrate through the holes in the mask. Figure 9B shows an enlarged partial view of Fig. 9A.